MAX30100

Pulse Oximeter and Heart-Rate Sensor IC for Wearable Health

General Description

The MAX30100 is an integrated pulse oximetry and heartrate monitor sensor solution. It combines two LEDs, a photodetector, optimized optics, and low-noise analog signal processing to detect pulse oximetry and heart-rate signals.

The MAX30100 operates from 1.8V and 3.3V power supplies and can be powered down through software with negligible standby current, permitting the power supply to remain connected at all times.

Applications

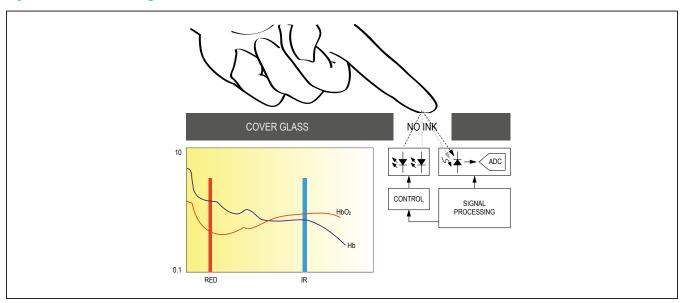
- Wearable Devices
- Fitness Assistant Devices
- Medical Monitoring Devices

Benefits and Features

- Complete Pulse Oximeter and Heart-Rate Sensor Solution Simplifies Design
 - Integrated LEDs, Photo Sensor, and High-Performance Analog Front -End
 - Tiny 5.6mm x 2.8mm x 1.2mm 14-Pin Optically Enhanced System-in-Package
- Ultra-Low-Power Operation Increases Battery Life for Wearable Devices
 - Programmable Sample Rate and LED Current for Power Savings
 - Ultra-Low Shutdown Current (0.7µA, typ)
- Advanced Functionality Improves Measurement Performance
 - High SNR Provides Robust Motion Artifact Resilience
 - Integrated Ambient Light Cancellation
 - · High Sample Rate Capability
 - · Fast Data Output Capability

Ordering Information appears at end of data sheet.

System Block Diagram





Absolute Maximum Ratings

V _{DD} to GND	0.3V to +2.2V
GND to PGND	0.3V to +0.3V
x_DRV, x_LED+ to PGND	0.3V to +6.0V
All Other Pins to GND	0.3V to +6.0V
Output Short-Circuit Current Duration	Continuous
Continuous Input Current into Any Terminal	±20mA

Continuous Power Dissipation ($T_A = +70$ °C)	
OESIP (derate 5.8mW/°C above +70°C)	464mW
Operating Temperature Range	40°C to +85°C
Soldering Temperature (reflow)	+260°C
Storage Temperature Range	40°C to +105°C

Package Thermal Characteristics (Note 1)

OFSIP

Junction-to-Ambient Thermal Resistance (θ_{JA})150°C/W Junction-to-Case Thermal Resistance (θ_{JC})......170°C/W

Note 1: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

Electrical Characteristics

 $(V_{DD} = 1.8V, V_{IR_LED+} = V_{R_LED+} = 3.3V, T_{A} = +25^{\circ}C, min/max \ are \ from \ T_{A} = -40^{\circ}C \ to \ +85^{\circ}C, unless \ otherwise \ noted.) \ (Note \ 2)$

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
POWER SUPPLY							
Power-Supply Voltage	V _{DD}	Guaranteed by RED and IR cou	ınt tolerance	1.7	1.8	2.0	V
LED Supply Voltage (R_LED+ or IR_LED+ to PGND)	V _{LED+}	Guaranteed by PSRR of LED D	river	3.1	3.3	5.0	V
Supply Current	1	SpO ₂ and heart rate modes, PW = 200µs, 50sps		600	1200		
Supply Current	I _{DD}	Heart rate only mode, PW = 200µs, 50sps			600	1200	μΑ
Supply Current in Shutdown	I _{SHDN}	T _A = +25°C, MODE = 0x80		0.7	10	μA	
SENSOR CHARACTERISTICS							
ADC Resolution					14		bits
Red ADC Count (Note 3)	RED _C	Propriety ATE setup RED_PA = 0x05, LED_PW = 0x SPO2_SR = 0x07, T _A = +25°C	:00,	23,000	26,000	29,000	Counts
IR ADC Count (Note 3)	IR _C	Propriety ATE setup IR_PA = 0x09, LED_PW = 0x00 SPO2_SR = 0x07, T _A = +25°C),	23,000	26,000	29,000	Counts
Dark Current Count	DC _C	RED_PA = IR_PA = 0x00, LED_PW = 0x03, SPO2_SR =	0x01		0	3	Counts
DC Ambient Light Rejection	DC Ambient Light Rejection ALR Supliciple (100K lux)		RED LED		0		Counts
Note 4)	ALIX	LED_PW = 0x03, SPO2_SR = 0x01	IR LED		0		Counts

Electrical Characteristics (continued)

 $(V_{DD} = 1.8V, V_{IR_LED+} = V_{R_LED+} = 3.3V, T_A = +25^{\circ}C, min/max \ are \ from \ T_A = -40^{\circ}C \ to \ +85^{\circ}C, unless \ otherwise \ noted.) \ (Note \ 2)$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
IR ADC Count—PSRR (V _{DD})	PSRR _{VDD}	Propriety ATE setup 1.7V < V _{DD} < 2.0V, LED_PW = 0x03, SPO2_SR = 0x01, IR_PA = 0x09, IR_PA = 0x05, T _A = +25°C		0.25	2	%
		Frequency = DC to 100kHz, 100mV _{P-P}		10		LSB
RED/IR ADC Count—PSRR (X_LED+)	PSRR _{LED}	Propriety ATE setup 3.1V < X_LED+ < 5V, LED_PW = 0x03, SPO2_SR = 0x01, IR_PA = 0x09, IR_PA = 0x05, T _A = +25°C		0.05	2	%
		Frequency = DC to 100kHz, 100mV _{P-P}		10		LSB
ADC Integration Time	INT	LED_PW = 0x00		200		μs
ADC Integration Time	IINI	LED_PW = 0x03		1600		μs
IR LED CHARACTERISTICS (Note	e 4)					
LED Peak Wavelength	λ _P	I _{LED} = 20mA, T _A = +25°C	870	880	900	nm
Full Width at Half Max	Δλ	I _{LED} = 20mA, T _A = +25°C		30		nm
Forward Voltage	V _F	I _{LED} = 20mA, T _A = +25°C		1.4		V
Radiant Power	PO	I _{LED} = 20mA, T _A = +25°C		6.5		mW
RED LED CHARACTERISTICS (N	ote 4)					
LED Peak Wavelength	λ _P	I _{LED} = 20mA, T _A = +25°C	650	660	670	nm
Full Width at Half Max	Δλ	I _{LED} = 20mA, T _A = +25°C		20		nm
Forward Voltage	V _F	I _{LED} = 20mA, T _A = +25°C		2.1		V
Radiant Power	PO	I _{LED} = 20mA, T _A = +25°C		9.8		mW
TEMPERATURE SENSOR						
Temperature ADC Acquisition Time	T _T	T _A = +25°C		29		ms
Temperature Sensor Accuracy	T _A	T _A = +25°C		±1		°C
Temperature Sensor Minimum Range	T _{MIN}			-40		°C
Temperature Sensor Maximum Range	T _{MAX}			85		°C

Electrical Characteristics (continued)

 $(V_{DD}$ = 1.8V, V_{IR} LED+ = V_{R} LED+ = 3.3V, T_{A} = +25°C, min/max are from T_{A} = -40°C to +85°C, unless otherwise noted.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
DIGITAL CHARACTERISTICS (SD	A, SDA, INT)					
Output Low Voltage SDA, INT	V _{OL}	I _{SINK} = 6mA			0.4	V
I ² C Input Voltage Low	V _{IL_I2C}	SDA, SCL			0.4	V
I ² C Input Voltage High	V _{IH_I2C}	SDA, SCL	1.4			V
Input Hysteresis	V _{HYS}	SDA, SCL		200		mV
Input Capacitance	C _{IN}	SDA, SCL		10		pF
Input Leakage Current	l	V _{IN} = 0V, T _A = +25°C (SDA, SCL, INT)		0.01	1	μA
input Leakage Guilent	I _{IN}	V _{IN} = 5.5V, T _A = +25°C (SDA, SCL, INT)		0.01	1	μΑ
I ² C TIMING CHARACTERISTICS (SDA, SDA, ĪNT	·)				
I ² C Write Address				AE		Hex
I ² C Read Address				AF		Hex
Serial Clock Frequency	f _{SCL}		0		400	kHz
Bus Free Time Between STOP and START Conditions	tBUF		1.3			μs
Hold Time (Repeated) START Condition	t _{HD,START}		0.6			μs
SCL Pulse-Width Low	t _{LOW}		1.3			μs
SCL Pulse-Width High	tHIGH		0.6			μs
Setup Time for a Repeated START Condition	t _{SU,START}		0.6			μs
Data Hold Time	t _{HD,DAT}		0		900	ns
Data Setup Time	tsu,dat		100			ns
Setup Time for STOP Condition	tsu,stop		0.6			μs
Pulse Width of Suppressed Spike	t _{SP}		0		50	ns
Bus Capacitance	C _B				400	pF
SDA and SCL Receiving Rise Time	t _R		20 + 0.1C _B	3	300	ns
SDA and SCL Receiving Fall Time	t _{RF}		20 + 0.1C _B	3	300	ns
SDA Transmitting Fall Time	t _{TF}		20 + 0.1C _B	3	300	ns

Note 2: All devices are 100% production tested at $T_A = +25$ °C. Specifications over temperature limits are guaranteed by Maxim Integrated's bench or proprietary automated test equipment (ATE) characterization.

Note 4: For design guidance only. Not production tested.

Note 3: Specifications are guaranteed by Maxim Integrated's bench characterization and by 100% production test using proprietary ATE setup and conditions.

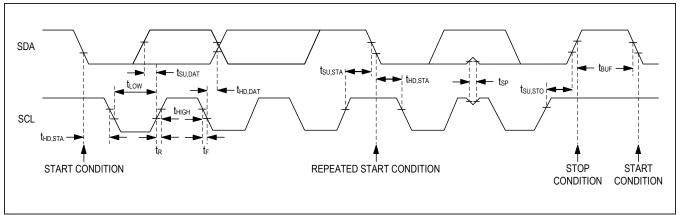
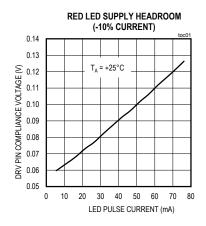
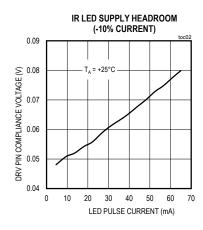


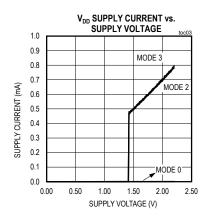
Figure 1. I²C-Compatible Interface Timing Diagram

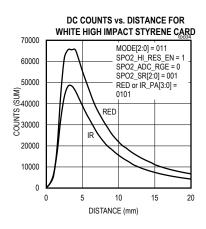
Typical Operating Characteristics

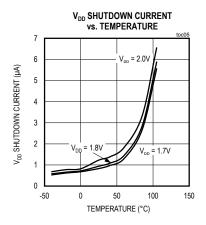
 $(V_{DD} = 1.8V, V_{IR} LED+ = V_{R} LED+ = 3.3V, T_{A} = +25^{\circ}C$, unless otherwise noted.)

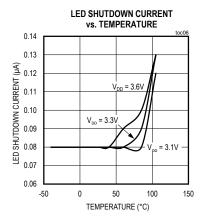


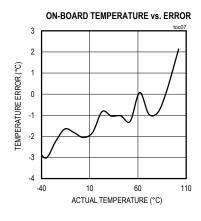


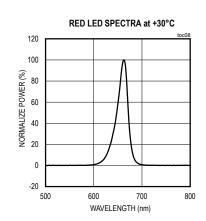






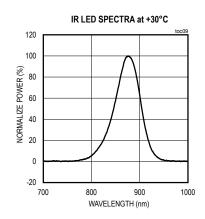


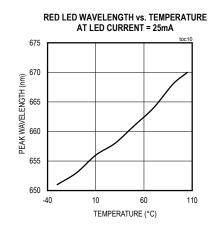


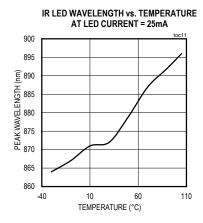


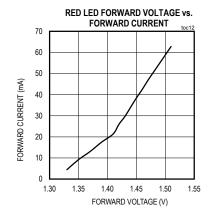
Typical Operating Characteristics (continued)

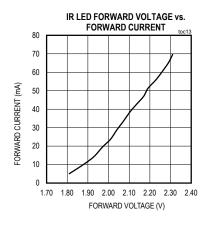
 $(V_{DD} = 1.8V, V_{IR} LED+ = V_{R} LED+ = 3.3V, T_{A} = +25$ °C, unless otherwise noted.)



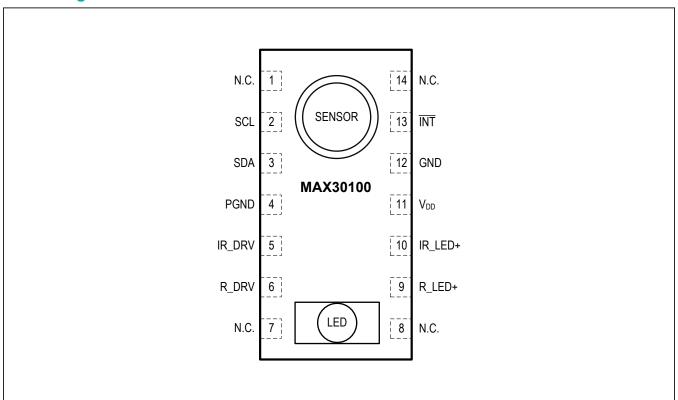








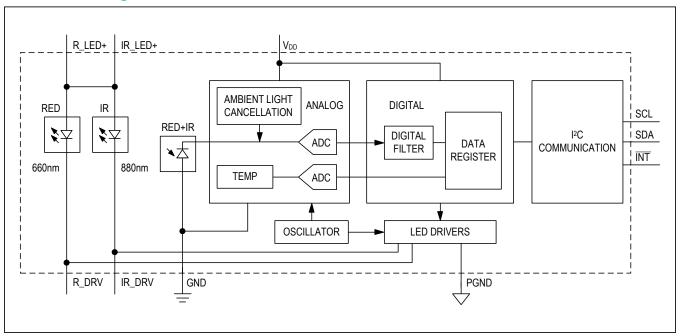
Pin Configuration



Pin Description

PIN	NAME	FUNCTION
1, 7, 8, 14	N.C.	No Connection. Connect to PCB Pad for Mechanical Stability.
2	SCL	I ² C Clock Input
3	SDA	I ² C Clock Data, Bidirectional (Open-Drain)
4	PGND	Power Ground of the LED Driver Blocks
5	IR_DRV	IR LED Cathode and LED Driver Connection Point. Leave floating in circuit.
6	R_DRV	Red LED Cathode and LED Driver Connection Point. Leave floating in circuit.
9	R_LED+	Power Supply (Anode Connection) for Red LED. Bypass to PGND for best performance. Connected to IR_LED+ internally.
10	IR_LED+	Power Supply (Anode Connection) for IR LED. Bypass to PGND for best performance. Connected to R_LED+ internally.
11	V _{DD}	Analog Power Supply Input. Bypass to GND for best performance.
12	GND	Analog Ground
13	ĪNT	Active-Low Interrupt (Open-Drain)

Functional Diagram



Detailed Description

The MAX30100 is a complete pulse oximetry and heartrate sensor system solution designed for the demanding requirements of wearable devices. The MAX30100 provides very small total solution size without sacrificing optical or electrical performance. Minimal external hardware components are needed for integration into a wearable device.

The MAX30100 is fully configurable through software registers, and the digital output data is stored in a 16-deep FIFO within the device. The FIFO allows the MAX30100 to be connected to a microcontroller or microprocessor on a shared bus, where the data is not being read continuously from the device's registers.

SpO₂ Subsystem

The SpO₂ subsystem in the MAX30100 is composed of ambient light cancellation (ALC), 16-bit sigma delta ADC, and proprietary discrete time filter.

The ${\rm SpO_2}$ ADC is a continuous time oversampling sigma delta converter with up to 16-bit resolution. The ADC output data rate can be programmed from 50Hz to 1kHz. The

MAX30100 includes a proprietary discrete time filter to reject 50Hz/60Hz interference and low-frequency residual ambient noise.

Temperature Sensor

The MAX30100 has an on-chip temperature sensor for (optionally) calibrating the temperature dependence of the SpO_2 subsystem.

The SpO_2 algorithm is relatively insensitive to the wavelength of the IR LED, but the red LED's wavelength is critical to correct interpretation of the data. The temperature sensor data can be used to compensate the SpO_2 error with ambient temperature changes.

LED Driver

The MAX30100 integrates red and IR LED drivers to drive LED pulses for ${\rm SpO_2}$ and HR measurements. The LED current can be programmed from 0mA to 50mA (typical only) with proper supply voltage. The LED pulse width can be programmed from 200 μ s to 1.6ms to optimize measurement accuracy and power consumption based on use cases.

Table 1. Register Maps and Descriptions

REGISTER	В7	В6	B5	B4	В3	B2	B1	В0	REG ADDR	POR STATE	R/W
STATUS											
Interrupt Status	A_FULL	TEMP_ RDY	HR_RDY	SPO2_ RDY				PWR_ RDY	0x00	0X00	R
Interrupt En- able	ENB_A_ FULL	ENB_TE P_RDY	ENB_HR_ RDY	ENB_S O2_RDY					0x01	0X00	R/W
FIFO											
FIFO Write Pointer						FIFO_WR	PTR[3:0]		0x02	0x00	R/W
Over Flow Counter						OVF_COL	JNTER[3:0]		0x03	0x00	R/W
FIFO Read Pointer					FIFO_RD_PTR[3:0]				0x04	0x00	R/W
FIFO Data Register				FIFO_DATA	A[7:0]				0x05	0x00	R/W
CONFIGURATIO	ON										
Mode Configu- ration	SHDN	RESET			TEMP_ EN		MODE[2:0]		0x06	0x00	R/W
SPO2 Configuration		SPO2_HI_ RES_EN	RE- SERVED	SF	PO2_SR[2:	0]	LED_F	PW[1:0]	0x07	0x00	R/W
RESERVED									0x08	0x00	R/W
LED Configura- tion		RED_I	PA[3:0]			IR_P	A[3:0]		0x09	0x00	R/W
RESERVED									0x0A - 0x15	0x00	R/W
TEMPERATURE											
Temp_Integer				TINT[7:	0]				0x16	0x00	R/W
Temp_Fraction					TFRAC[3:0]				0x17	0x00	R/W
RESERVED									0x8D	0x00	R/W
PART ID											
Revision ID				REV_ID[7:0]				0xFE	0xXX*	R
Part ID				PART_I	0[7]				0xFF	0x11	R/W

^{*}XX denotes any 2-digit hexidecimal number (00 to FF). Contact Maxim Integrated for the Revision ID number assigned for your product.

Interrupt Status (0x00)

REGISTER	В7	В6	В5	B4	В3	B2	B1	В0	REG ADDR	POR STATE	R/W
Interrupt Status	A_FULL	TEMP_ RDY	HR_RDY	SPO2_ RDY				PWR_ RDY	0x00	0X00	R

There are 5 interrupts and the functionality of each is exactly the same: pulling the active-low interrupt pin into its low state until the interrupt is cleared.

The interrupts are cleared whenever the interrupt status register is read, or when the register that triggered the interrupt is read. For example, if the SpO_2 sensor triggers an interrupt due to finishing a conversion, reading either the FIFO data register or the interrupt register clears the interrupt pin (which returns to its normal high state), and also clears all the bits in the interrupt status register to zero.

Bit 7: FIFO Almost Full Flag (A FULL)

In SpO₂ and heart-rate modes, this interrupt triggers when the FIFO write pointer is the same as the FIFO read pointer minus one, which means that the FIFO has only one unwritten space left. If the FIFO is not read within the next conversion time, the FIFO becomes full and future data is lost.

Bit 6: Temperature Ready Flag (TEMP_RDY)

When an internal die temperature conversion is finished, this interrupt is triggered so the processor can read the temperature data registers.

Bit 5: Heart Rate Data Ready (HR_RDY)

In heart rate or SPO₂ mode, this interrupt triggers after every data sample is collected. A heart rate data sample consists of one IR data point only. This bit is automatically cleared when the FIFO data register is read.

Bit 4: SpO₂ Data Ready (SPO2_RDY)

In SpO_2 mode, this interrupt triggers after every data sample is collected. An SpO_2 data sample consists of one IR and one red data points. This bit is automatically cleared when the FIFO data register is read.

Bit 3: RESERVED

This bit should be ignored and always be zero in normal operation.

Bit 2: RESERVED

This bit should be ignored and always be zero in normal operation.

Bit 1: RESERVED

This bit should be ignored and always be zero in normal operation.

Bit 0: Power Ready Flag (PWR_RDY)

On power-up or after a brownout condition, when the supply voltage V_{DD} transitions from below the UVLO voltage to above the UVLO voltage, a power-ready interrupt is triggered to signal that the IC is powered up and ready to collect data.

Interrupt Enable (0x01)

REGISTER	В7	В6	B5	B4	В3	B2	B1	В0	REG ADDR	POR STATE	R/W
Interrupt Enable	ENB_A_ FULL	ENB_TE P_RDY	ENB_HR_ RDY	ENB_S O2_RDY					0x01	0X00	R/W

Each source of hardware interrupt, with the exception of power ready, can be disabled in a software register within the MAX30100 IC. The power-ready interrupt cannot be disabled because the digital state of the MAX30100 is reset upon a brownout condition (low power-supply voltage), and the default state is that all the interrupts are disabled. It is important for the system to know that a brownout condition has occurred, and the data within the device is reset as a result.

When an interrupt enable bit is set to zero, the corresponding interrupt appears as 1 in the interrupt status register, but the $\overline{\text{INT}}$ pin is not pulled low.

The four unused bits (B3:B0) should always be set to zero (disabled) for normal operation.

FIFO (0x02-0x05)

REGISTER	В7	В6	B5	B4	В3	B2	B1	В0	REG ADDR	POR STATE	R/W
FIFO Write Pointer						FIFO_WR	0x02	0x00	R/W		
Over Flow Counter						OVF_COL	JNTER[3:0]		0x03	0x00	R/W
FIFO Read Pointer						FIFO_RD	_PTR[3:0]		0x04	0x00	R/W
FIFO Data Register				FIFO_DATA	A[7:0]				0x05	0x00	R/W

FIFO Write Pointer

The FIFO write pointer points to the location where the MAX30100 writes the next sample. This pointer advances for each sample pushed on to the FIFO. It can also be changed through the I²C interface when MODE[2:0] is nonzero.

FIFO Overflow Counter

When the FIFO is full, samples are not pushed on to the FIFO, samples are lost. OVF_COUNTER counts the number of samples lost. It saturates at 0xF. When a complete sample is popped from the FIFO (when the read pointer advances), OVF_COUNTER is reset to zero.

FIFO Read Pointer

The FIFO read pointer points to the location from where the processor gets the next sample from the FIFO via the I²C interface. This advances each time a sample is popped from the FIFO. The processor can also write to this pointer after reading the samples, which would allow rereading samples from the FIFO if there is a data communication error.

FIFO Data

The circular FIFO depth is 16 and can hold up to 16 samples of SpO₂ channel data (Red and IR). The FIFO_DATA register in the I²C register map points to the next sample to be read from the FIFO. FIFO_RD_PTR points to this sample. Reading FIFO_DATA register does not automatically increment the register address; burst reading this register reads the same address over and over. Each sample is 4 bytes of data, so this register has to be read 4 times to get one sample.

The above registers can all be written and read, but in practice, only the FIFO_RD_PTR register should be written to in operation. The others are automatically incremented or filled with data by the MAX30100. When starting a new SpO₂

or heart-rate conversion, it is recommended to first clear the FIFO_WR_PTR, OVF_COUNTER, and FIFO_RD_PTR registers to all zeros (0x00) to ensure the FIFO is empty and in a known state. When reading the MAX30100 registers in one burst-read I²C transaction, the register address pointer typically increments so that the next byte of data sent is from the next register, etc. The exception to this is the FIFO data register, register 0x05. When reading this register, the address pointer does not increment, but the FIFO_RD_PTR does. So the next byte of data sent will represent the next byte of data available in the FIFO.

Reading from the FIFO

Normally, reading registers from the I²C interface autoincrements the register address pointer, so that all the registers can be read in a burst read without an I²C restart event. In the MAX30100, this holds true for all registers except for the FIFO_DATA register (0x05).

Reading the FIFO_DATA register does not automatically increment the register address; burst reading this register reads the same address over and over. Each sample is 4 bytes of data, so this register has to be read 4 times to get one sample.

The other exception is 0xFF, reading more bytes after the 0xFF register does not advance the address pointer back to 0x00, and the data read is not meaningful.

FIFO Data Structure

The data FIFO consists of a 16-sample memory bank that stores both IR and RED ADC data. Since each sample consists of one IR word and one RED word, there are 4 bytes of data for each sample, and therefore, 64 total bytes of data can be stored in the FIFO. Figure 2 shows the structure of the FIFO graphically.

The FIFO data is left-justified as shown in <u>Table 1</u>; i.e. the MSB bit is always in the bit 15 position regardless of ADC resolution.

Each data sample consists of an IR and a red data word (2 registers), so to read one sample requires 4 I²C byte reads in a row. The FIFO read pointer is automatically incremented after each 4-byte sample is read.

In heart-rate only mode, the 3rd and 4th bytes of each sample return zeros, but the basic structure of the FIFO remains the same.

Write/Read Pointers

Table 2. FIFO Data

ADC RESOLUTION	IR [15]	IR [14]	IR [13]	IR [12]	IR [11]	IR [10]	IR [9]	IR [8]	IR [7]	IR [6]	IR [5]	IR [4]	IR [3]	IR [2]	IR [1]	IR [0]
16-bit																
14-bit																
12-bit																
10-bit																

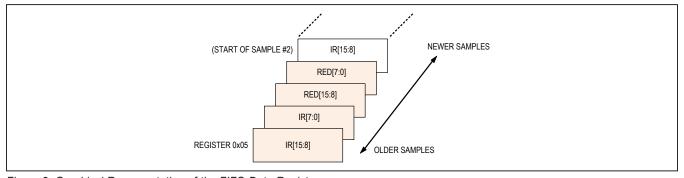


Figure 2. Graphical Representation of the FIFO Data Register

The locations to store new data, and the read pointer for reading data, are used to control the flow of data in the FIFO. The write pointer increments every time a new sample is added to the FIFO. The read pointer is incremented automatically every time a sample is read from the FIFO. To reread a sample from the FIFO, decrement its value by one and read the data register again.

The SpO_2 write/read pointers should be cleared (back to 0x0) upon entering SpO_2 mode or heart-rate mode, so that there is no old data represented in the FIFO. The pointers are not automatically cleared when changing modes, but they are cleared if V_{DD} is power cycled so that the V_{DD} voltage drops below its UVLO voltage.

Pseudo-Code Example of Reading Data from FIFO

First transaction: Get the FIFO_WR_PTR:

```
START;
Send device address + write mode
Send address of FIFO_WR_PTR;
REPEATED_START;
Send device address + read mode
Read FIFO_WR_PTR;
STOP:
```

The central processor evaluates the number of samples to be read from the FIFO:

```
NUM_AVAILABLE_SAMPLES = FIFO_WR_PTR - FIFO_RD_PTR
(Note: pointer wrap around should be taken into account)
NUM_SAMPLES_TO_READ = < less than or equal to NUM_AVAILABLE_SAMPLES >
```

Second transaction: Read NUM SAMPLES TO READ samples from the FIFO:

```
START;
Send device address + write mode
Send address of FIFO_DATA;
REPEATED_START;
Send device address + read mode
for (i = 0; i < NUM_SAMPLES_TO_READ; i++) {
Read FIFO_DATA;
Save IR[15:8];
Read FIFO_DATA;
Save IR[7:0];
Read FIFO_DATA;
Save R[15:8];
Read FIFO_DATA;
Save R[15:8];</pre>
```

Third transaction: Write to FIFO_RD_PTR register. If the second transaction was successful, FIFO_RD_PTR points to the next sample in the FIFO, and this third transaction is not necessary. Otherwise, the processor updates the FIFO RD PTR appropriately, so that the samples are reread.

```
START;
Send device address + write mode
Send address of FIFO_RD_PTR;
Write FIFO_RD_PTR;
STOP;
```

Mode Configuration (0x06)

REGISTER	В7	В6	B5	B4	В3	B2	B1	В0	REG ADDR	POR STATE	R/W
Mode Configu- ration	SHDN	RESET			TEMP_ EN		MODE[2:0]		0x06	0x00	R/W

Bit 7: Shutdown Control (SHDN)

The part can be put into a power-save mode by setting this bit to one. While in power-save mode, all registers retain their values, and write/read operations function as normal. All interrupts are cleared to zero in this mode.

Bit 6: Reset Control (RESET)

When the RESET bit is set to one, all configuration, threshold, and data registers are reset to their power-on-state. The only exception is writing both RESET and TEMP_EN bits to one at the same time since temperature data registers 0x16 and 0x17 are not cleared. The RESET bit is cleared automatically back to zero after the reset sequence is completed.

Bit 3: Temperature Enable (TEMP_EN)

This is a self-clearing bit which, when set, initiates a single temperature reading from the temperature sensor. This bit is cleared automatically back to zero at the conclusion of the temperature reading when the bit is set to one in heart rate or SpO_2 mode.

Bits 2:0: Mode Control

These bits set the operating state of the MAX30100. Changing modes does not change any other setting, nor does it erase any previously stored data inside the data registers.

Table 3. Mode Control

MODE[2:0]	MODE		
000	Unused		
001	Reserved (Do not use)		
010	HR only enabled		
011	SPO ₂ enabled		
100–111	Unused		

SpO2 Configuration (0x07)

REGISTER	В7	В6	B5	B4	В3	B2	B1	В0	REG ADDR	POR STATE	R/W
SPO ₂ Configuration		SPO2_HI_ RES_EN	Reserved	SPO2_SR[2:0]		LED_F	PW[1:0]	0x07	0x00	R/W	

Bit 6: SpO₂ High Resolution Enable (SPO2_HI_RES_EN)

Set this bit high. The SpO₂ ADC resolution is 16-bit with 1.6ms LED pulse width.

Bit 5: Reserved. Set low (default).

Bit 4:2: SpO₂ Sample Rate Control

These bits define the effective sampling rate, with one sample consisting of one IR pulse/conversion and one RED pulse/conversion.

The sample rate and pulse width are related, in that the sample rate sets an upper bound on the pulse width time. If the user selects a sample rate that is too high for the selected LED_PW setting, the highest possible sample rate will instead be programmed into the register.

Bits 1:0: LED Pulse Width Control

These bits set the LED pulse width (the IR and RED have the same pulse width), and therefore, indirectly set the integration time of the ADC in each sample. The ADC resolution is directly related to the integration time.

Table 4. SpO₂ Sample Rate Control

SPO2_SR[2:0]	SAMPLES (PER SECOND)
000	50
001	100
010	167
011	200
100	400
101	600
110	800
111	1000

Table 5. LED Pulse Width Control

LED_PW[1:0]	PULSE WIDTH (μs)	ADC RESOLUTION (BITS)
00	200	13
01	400	14
10	800	15
11	1600	16

LED Configuration (0x09)

REGISTER	В7	В6	B5	B4	В3	B2	B1	В0	REG ADDR	POR STATE	R/W
LED Configura- tion		RED_I	PA[3:0]			IR_PA[3:0]		0x09	0x00	R/W	

Bits 7:4: Red LED Current Control

These bits set the current level of the Red LED as in Table 6.

Bits 3:0: IR LED Current Control

These bits set the current level of the IR LED as in Table 6.

Table 6. LED Current Control

Red_PA[3:0] OR IR_PA[3:0]	TYPICAL LED CURRENT (mA)*
0000	0.0
0001	4.4
0010	7.6
0011	11.0
0100	14.2
0101	17.4
0110	20.8
0111	24.0
1000	27.1
1001	30.6
1010	33.8
1011	37.0
1100	40.2
1101	43.6
1110	46.8
1111	50.0

^{*}Actual measured LED current for each part can vary widely due to the proprietary trim methodology.

Temperature Data (0x16-0x17)

REGISTER	В7	В6	B5	B4	В3	B2	B1	В0	REG ADDR	POR STATE	R/W
Temp_Integer		TINT[7:0]						0x16	0x00	R/W	
Temp_Fraction					TFRAC[3:0]			0x17	0x00	R/W	

Temperature Integer

The on-board temperature ADC output is split into two registers, one to store the integer temperature and one to store the fraction. Both should be read when reading the temperature data, and the following equation shows how to add the two registers together:

This register stores the integer temperature data in two's complement format, where each bit corresponds to degree Celsius.

Table 7. Temperature Integer

REGISTER VALUE (hex)	TEMPERATURE (°C)
0x00	0
0x00	+1
0x7E	+126
0x7F	+127
0x80	-128
0x81	-127
0xFE	-2
0xFF	-1

Temperature Fraction

This register stores the fractional temperature data in increments of 0.0625°C (1/16th of a degree).

If this fractional temperature is paired with a negative integer, it still adds as a positive fractional value (e.g., $-128^{\circ}\text{C} + 0.5^{\circ}\text{C} = -127.5^{\circ}\text{C}$).

Applications Information

Sampling Rate and Performance

The MAX30100 ADC is a 16-bit sigma delta converter. The ADC sampling rate can be configured from 50sps to 1ksps. The maximum sample rate for the ADC depends on the selected pulse width, which in turn, determines the ADC resolution. For instance, if the pulse width is set to 200µs, then the ADC resolution is 13 bits and all sample rates from 50sps to 1ksps are selectable. However, if the pulse width is set to 1600µs, then only sample rates of 100sps and 50sps can be set. The allowed sample rates for both SpO2 and HR mode are summarized in Table 8 and Table 9.

Power Considerations

The LEDs in MAX30100 are pulsed with a low duty cycle for power savings, and the pulsed currents can cause ripples in the LED power supply. To ensure these pulses do not translate into optical noise at the LED outputs, the power supply must be designed to handle peak LED current. Ensure that the resistance and inductance from the

power supply (battery, DC/DC converter, or LDO) to the device LED+ pins is much smaller than 1Ω , and that there is at least $1\mu F$ of power-supply bypass capacitance to a low impedance ground plane. The decoupling capacitor should be located physically as close as possible to the MAX30100 device.

In the heart-rate only mode, the red LED is inactive, and only the IR LED is used to capture optical data and determine the heart rate. This mode allows power savings due to the red LED being off; in addition, the IR_LED+ power supply can be reduced to save power because the forward voltage of the IR LED is significantly less than that of the red LED.

The average I_{DD} and LED current as function of pulse width and sampling rate is summarized in <u>Table 10</u> to Table 13.

Table 8. SpO₂ Mode (Allowed Settings)

SAMPLES	PULSE WIDTH (μs)							
(per second)	200	400	800	1600				
50	0	0	0	0				
100	0	0	0	0				
167	0	0	0					
200	0	0	0					
400	0	0						
600	0							
800	0							
1000	0							
Resolution (bits)	13	14	15	16				

Table 9. Heart-Rate Mode (Allowed Settings)

SAMPLES	PULSE WIDTH (μs)							
(per second)	200	400	800	1600				
50	0	0	0	0				
100	0	0	0	0				
167	0	0	0					
200	0	0	0					
400	0	0						
600	0	0						
800	0	0						
1000	0	0						
Resolution (bits)	13	14	15	16				

Table 10. SpO_2 Mode: Average IDD Current (μ A) R PA = 0x3, IR PA = 0x3

SAMPLES	PULSE WIDTH (µs)							
(per second)	200	400	800	1600				
50	628	650	695	782				
100	649	691	776	942				
167	678	748	887					
200	692	775	940					
400	779	944						
600	865							
800	952							
1000	1037							

Table 11. SpO₂ Mode: Average LED Current (mA) R_PA = 0x3, IR_PA = 0x3

SAMPLES	PULSE WIDTH (μs)							
(per second)	200	400	800	1600				
50	0.667	1.332	2.627	5.172				
100	1.26	2.516	4.96	9.766				
167	2.076	4.145	8.173					
200	2.491	4.93	9.687					
400	4.898	9.765						
600	7.319							
800	9.756							
1000	12.17							

Hardware Interrupt

The active-low interrupt pin pulls low when an interrupt is triggered. The pin is open-drain and requires a pullup resistor or current source to an external voltage supply (up to +5V from GND). The interrupt pin is not designed to sink large currents, so the pullup resistor value should be large, such as $4.7 k\Omega.$

The internal FIFO stores up to 16 samples, so that the system processor does not need to read the data after

Table 12. Heart-Rate Mode: Average IDD Current (μA) IR_PA = 0x3

SAMPLES	PULSE WIDTH (μs)				
(per second)	200	400	800	1600	
50	608	616	633	667	
100	617	634	669	740	
167	628	658	716	831	
200	635	670	739	876	
400	671	740	878		
600	707	810			
800	743	881			
1000	779	951			

Table 13. Heart-Rate Mode: Average LED Current (mA) IR_PA = 0x3

SAMPLES	PULSE WIDTH (μs)				
(per second)	200	400	800	1600	
50	0.256	0.511	1.020	2.040	
100	0.512	1.022	2.040	4.077	
167	0.854	1.705	3.404	6.795	
200	1.023	2.041	4.074	8.130	
400	2.042	4.074	8.123		
600	3.054	6.089			
800	4.070	8.109			
1000	5.079	10.11			

every sample. Temperature data may be needed to properly interpret SpO_2 data, but the temperature does not need to be sampled very often—once a second or every few seconds should be sufficient. In heart-rate mode temperature information is not necessary.

Table 14. Red LED Current Settings vs. LED Temperature Rise

RED LED CURRENT SETTING	RED LED DUTY CYCLE (% OF LED PULSE WIDTH TO SAMPLE TIME)	ESTIMATED TEMPERATURE RISE (ADD TO TEMPERATURE SENSOR MEASUREMENT) (°C)
0001 (3.1mA)	8	0.1
1111 (35mA)	8	2
0001 (3.1mA)	16	0.3
1111 (35mA)	16	4
0001 (3.1mA)	32	0.6
1111 (35mA)	32	8

Timing for Measurements and Data Collection

Timing in SpO₂ Mode

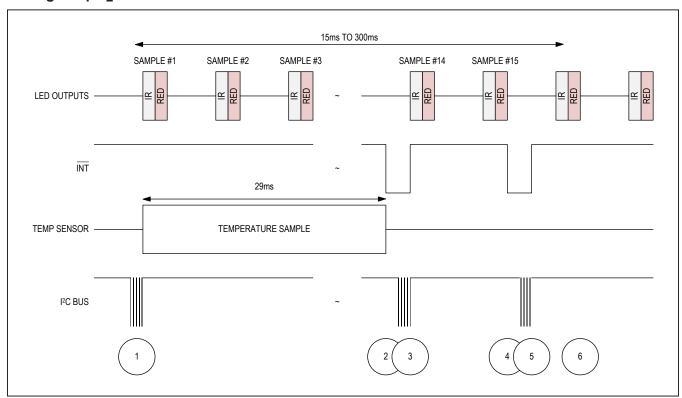


Figure 3. Timing for Data Acquisition and Communication When in $\ensuremath{\mathsf{SpO}}_2$ Mode

Table 15. Events Sequence for Figure 3 in SpO₂ Mode

EVENT	DESCRIPTION	COMMENTS
1	Enter into SpO ₂ mode. Initiate a temperature measurement.	I ² C Write Command Sets MODE[2:0] = 0x03. At the same time, set the TEMP_EN bit to initiate a single temperature measurement. Mask the SPO2_RDY Interrupt.
2	Temperature measurement complete, interrupt generated	TEMP_RDY interrupt triggers, alerting the central processor to read the data.
3	Temp data is read, interrupt cleared	
4	FIFO is almost full, interrupt generated	Interrupt is generated when the FIFO has only one empty space left.
5	FIFO data is read, interrupt cleared	
6	Next sample is stored	New sample is stored at the new read pointer location. Effectively, it is now the first sample in the FIFO.

Timing in Heart-Rate Mode

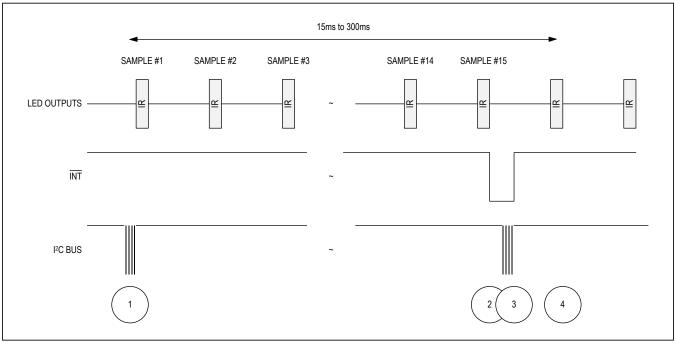


Figure 4. Timing for Data Acquisition and Communication When in Heart Rate Mode

Table 16. Events Sequence for Figure 4 in Heart-Rate Mode

EVENT	DESCRIPTION	COMMENTS
1	Enter into heart rate mode	I ² C Write Command Sets MODE[2:0] = 0x02. Mask the HR_RDY interrupt.
2	FIFO is almost full, interrupt generated	Interrupt is generated when the FIFO has only one empty space left.
3	FIFO data is read, interrupt cleared	
4	Next sample is stored	New sample is stored at the new read pointer location. Effectively, it is now the first sample in the FIFO.

Power Sequencing and Requirements

Power-Up Sequencing

Figure 5 shows the recommended power-up sequence for the MAX30100.

It is recommended to power the V_{DD} supply first, before the LED power supplies (R_LED+, IR_LED+). The interrupt and I²C pins can be pulled up to an external voltage even when the power supplies are not powered up.

After the power is established, an interrupt occurs to alert the system that the MAX30100 is ready for operation. Reading the I^2C interrupt register clears the interrupt, as shown in Figure 5.

Power-Down Sequencing

The MAX30100 is designed to be tolerant of any power-supply sequencing on power-down.

I2C Interface

The MAX30100 features an I²C/SMBus-compatible, 2-wire serial interface consisting of a serial data line (SDA) and a serial clock line (SCL). SDA and SCL facilitate communication between the MAX30100 and the master at clock rates up to 400kHz. Figure 1 shows the 2-wire interface timing diagram. The master generates SCL and initiates data transfer on the bus. The master device writes data to the MAX30100 by transmitting the proper slave address followed by data. Each transmit sequence is framed by a START (S) or REPEATED START (Sr) condition and a STOP (P) condition. Each word transmitted to the MAX30100 is 8 bits long and is followed by an acknowledge clock pulse. A master reading data from the MAX30100 transmits the proper slave address followed by a series of nine SCL pulses.

The MAX30100 transmits data on SDA in sync with the master-generated SCL pulses. The master acknowledges receipt of each byte of data. Each read sequence is framed by a START (S) or REPEATED START (Sr) condition, a not acknowledge, and a STOP (P) condition. SDA operates as both an input and an open-drain output. A pullup resistor, typically greater than 500Ω , is required on SDA. SCL operates only as an input. A pullup resistor, typically greater than 500Ω , is required on SCL if there are multiple masters on the bus, or if the single master has an open-drain SCL output.

Bit Transfer

One data bit is transferred during each SCL cycle. The data on SDA must remain stable during the high period of the SCL pulse. Changes in SDA while SCL is high are control signals. See the <u>START and STOP Conditions</u> section.

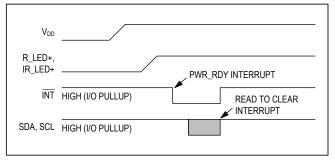


Figure 5. Power-Up Sequence of the Power-Supply Rails

START and STOP Conditions

SDA and SCL idle high when the bus is not in use. A master initiates communication by issuing a START condition. A START condition is a high-to-low transition on SDA with SCL high. A STOP condition is a low-to-high transition on SDA while SCL is high (Figure 6). A START condition from the master signals the beginning of a transmission to the MAX30100. The master terminates transmission, and frees the bus, by issuing a STOP condition. The bus remains active if a REPEATED START condition is generated instead of a STOP condition.

Early STOP Conditions

The MAX30100 recognizes a STOP condition at any point during data transmission except if the STOP condition occurs in the same high pulse as a START condition. For proper operation, do not send a STOP condition during the same SCL high pulse as the START condition.

Slave Address

A bus master initiates communication with a slave device by issuing a START condition followed by the 7-bit slave ID. When idle, the MAX30100 waits for a START condition followed by its slave ID. The serial interface compares each slave ID bit by bit, allowing the interface to power down and disconnect from SCL immediately if an incorrect slave ID is detected. After recognizing a START condition followed by the correct slave ID, the MAX30100 is ready to accept or send data. The LSB of the slave

ID word is the Read/Write (R/W) bit. R/W indicates whether the master is writing to or reading data from the MAX30100. R/W = 0 selects a write condition, R/W = 1 selects a read condition). After receiving the proper slave ID, the MAX30100 issues an ACK by pulling SDA low for one clock cycle.

The MAX30100 slave ID consists of seven fixed bits, B7–B1 (set to 0b1010111). The most significant slave ID bit (B7) is transmitted first, followed by the remaining bits. Table 18 shows the possible slave IDs of the device.

Acknowledge

The acknowledge bit (ACK) is a clocked 9th bit that the MAX30100 uses to handshake receipt each byte of data when in write mode (Figure 7). The MAX30100 pulls down SDA during the entire master-generated 9th clock pulse if the previous byte is successfully received. Monitoring ACK allows for detection of unsuccessful data transfers. An unsuccessful data transfer occurs if a receiving device is busy or if a system fault has occurred. In the event of an unsuccessful data transfer, the bus master will retry communication. The master pulls down SDA during the 9th clock cycle to acknowledge receipt of data when the MAX30100 is in read mode. An acknowledge is sent by the master after each read byte to allow data transfer to continue. A not-acknowledge is sent when the master reads the final byte of data from the MAX30100, followed by a STOP condition.

Table 17. Slave ID Description

В7	В6	B5	B4	В3	B2	B1	В0	WRITE AD- DRESS	READ AD- DRESS
1	0	1	0	1	1	1	R/W	0xAE	0xAF

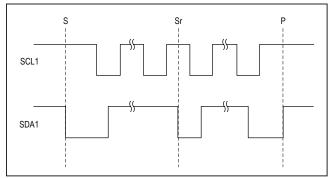


Figure 6. START, STOP, and REPEATED START Conditions

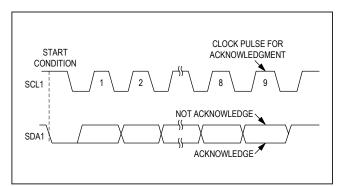


Figure 7. Acknowledge

Write Data Format

For the write operation, send the slave ID as the first byte followed by the register address byte and then one or more data bytes. The register address pointer increments automatically after each byte of data received. For example, the entire register bank can be written by at one time. Terminate the data transfer with a STOP condition. The write operation is shown in Figure 8.

The internal register address pointer increments automatically, so writing additional data bytes fill the data registers in order.

Read Data Format

For the read operation, two I²C operations must be performed. First, the slave ID byte is sent followed by the I²C register that you wish to read. Then a REPEATED START (Sr) condition is sent, followed by the read slave ID. The MAX30100 then begins sending data beginning with the register selected in the first operation. The read pointer

increments automatically, so the MAX30100 continues sending data from additional registers in sequential order until a STOP (P) condition is received. The exception to this is the FIFO_DATA register, at which the read pointer no longer increments when reading additional bytes. To read the next register after FIFO_DATA, an I²C write command is necessary to change the location of the read pointer.

An initial write operation is required to send the read register address.

Data is sent from registers in sequential order, starting from the register selected in the initial I²C write operation. If the FIFO_DATA register is read, the read pointer does not automatically increment, and subsequent bytes of data contain the contents of the FIFO.

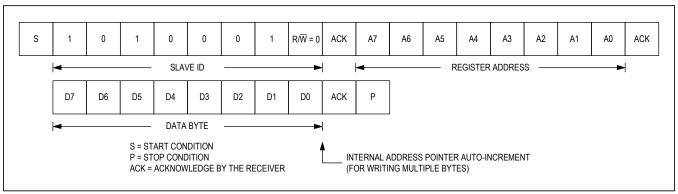


Figure 8. Writing One Data Byte to the MAX30100

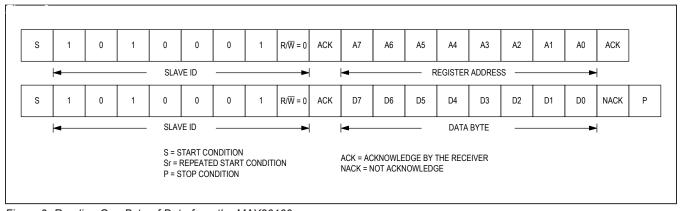


Figure 9. Reading One Byte of Data from the MAX30100

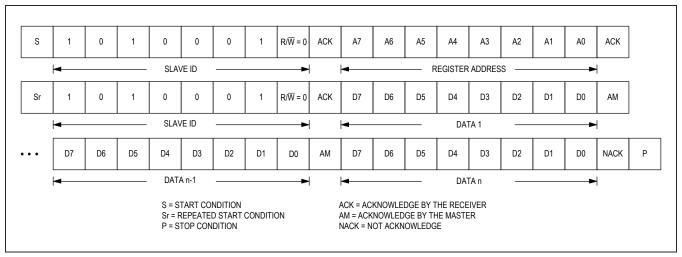
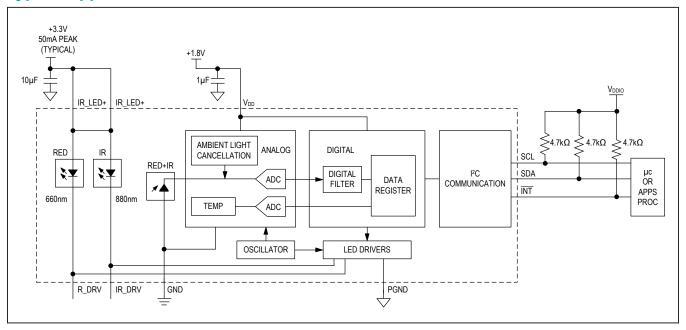


Figure 10. Reading Multiple Bytes of Data from the MAX30100

Typical Application Circuit



Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX30100EFD+	-40°C to +85°C	14 OESIP (0.8mm pitch)

⁺Denotes a lead(Pb)-free/RoHS-compliant package.

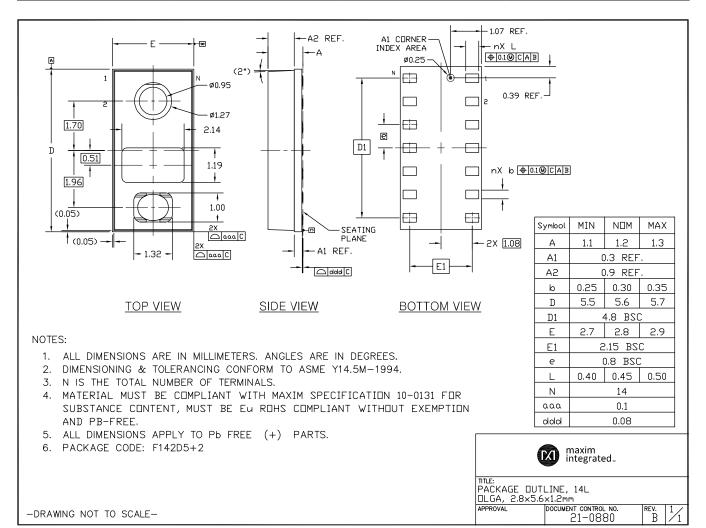
Chip Information

PROCESS: BICMOS

Package Information

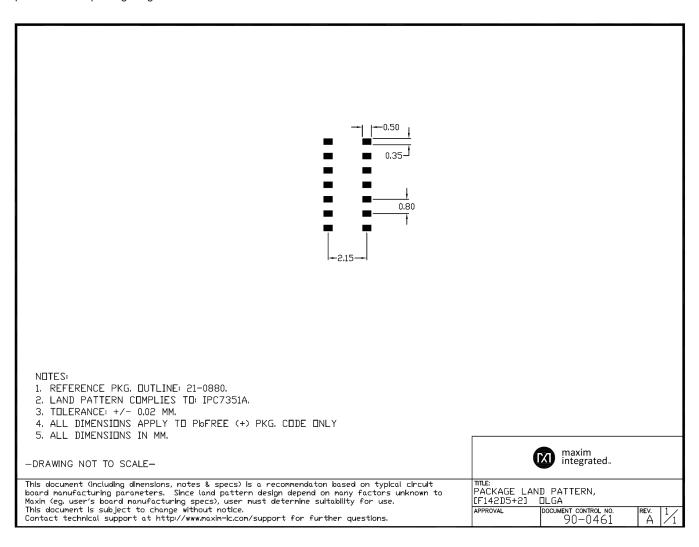
For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.
14 OESIP	F142D5+2	21-0880	90-0461



Package Information (continued)

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.



MAX30100

Pulse Oximeter and Heart-Rate Sensor IC for Wearable Health

Revision History

REVISION	REVISION	DESCRIPTION	PAGES
NUMBER	DATE		CHANGED
0	9/14	Initial release	_

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim Integrated's website at www.maximintegrated.com.

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